

Final Product Change Notification

Issue Date: 30-Sep-2020 Effective Date: 28-Dec-2020

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Management Summary

In order to secure the customer delivery and fab capacity, enable TSMC F10 to support NX20P0408 manufacturing as 2nd source.

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[] Wafer Fab Process	,	[] Product Marking	[] Test	[] Design
	Process		Location	
[] Wafer Fab Materials	[] Assembly	[] Mechanical	[]Test	[]Errata
••	Materials	Specification	Process	
[X] Wafer Fab Location	[] Assembly	•	[]Test	[] Electrica
[A] Waler Lab Lebadieri	Location	Packing/Shipping/Labeling		spec./Test
	Location	r acking/Shipping/Labeling	Equipment	•
				coverage
[] Firmware	[] Other			

NX20P0408 FAB EXPANSION (SSMC TO TSMC F10)

Description of Change

NXP Semiconductors is announcing the introduction of Taiwan Semiconductor Manufacturing Company Fab 10 (TSMC F10), Shanghai, China as a dual source wafer manufacturing location for the NX20P0408 (WLCSP12).

Reason for Change

The Fab manufacturing site capacity expansion to TSMC F10 will improve NXP's ability to meet increasing customer demand and still maintain supply from the original Fab (SSMC).

Identification of Affected Products

Top side marking

The last 5 digits of the Mask ID marking will change from ZYWW to NYWW. 'Z' for SSMC; 'N' for TSMC10.

Product Availability

Sample Information

Samples are available upon request

Production

Planned first shipment 28-Dec-2020

Anticipated Impact on Form, Fit, Function, Reliability or Quality

No impact on form, fit, function, reliability or quality.

Data Sheet Revision

No impact to existing datasheet

Disposition of Old Products

Fab Expansion. No Depletion of Inventory required.

Timing and Logistics

In compliance with JEDEC J-STD-046, your acknowledgement of this change is expected by 29-Oct-2020.

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

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Customer Focus, Passion to Win.

NXP Quality Management Team.

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Changed Orderable Part# Changed Part 12NC Changed Part Number Changed Part Description Package Name Status Product Line

NX20P0408UKZ 935374896012 NX20P0408UK USB Type C CC/SBU1/2 Protection IC WLCSP12 RFS Embedded Power